

PATENT ASSIGNMENT COVER SHEET

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NATURE OF CONVEYANCE:	ASSIGNMENT
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JOERG PALM	07/14/2020
HELMUT VOGT	07/15/2020
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PROPERTY NUMBERS Total: 1	
Property Type	Number
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DATE SIGNED:	09/01/2020
Total Attachments: 4	
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ASSIGNMENT

We, Andreas HEISS, residing in Germany with a mailing address at Wessobrunner Ring 15, Penzing, DE 86929,

Joerg PALM, residing in Germany with a mailing address at Agnes-Neuhaus-Strasse 16, Munich, DE 80797, and

Helmut VOGT, residing in Germany with a mailing address at Milbertshofener Strasse 67, Munich, DE 80807

hereby sell and assign for good and valuable consideration, the receipt of which we hereby acknowledge,

to (CNBM) BENGBU DESIGN & RESEARCH INSTITUTE FOR GLASS INDUSTRY CO., LTD, an entity having its principal place of business in China at No. 1047 Tushan Road, Bengbu, CN 233010

hereinafter referred to as the assignee, its successors, assigns and nominees, our entire right, title and interest, including all priority rights under U.S. law and/or International conventions and treaties, in and to the "SEMITRANSSPARENT THIN-FILM SOLAR MODULE"

invented by us, as described and/or claimed in International Application No. PCT/CN2018/107709, filed on September 26, 2018, in the corresponding U.S. National Phase Patent Application No. 16/649,979, filed March 23, 2020, and in any other related patent applications filed and/or to be filed not only for, to and in the United States of America its territories and possessions, but also for, to and in all other countries, including any and all divisions, continuations, and continuations-in-part of said International Application PCT/CN2018/107709, and any and all divisions, reissues, continuations, continuations-in-part and extensions of said corresponding U.S. National Phase Patent Application. We hereby authorize and request any officials whose duty it is to issue patents, to issue any patent on said "SEMITRANSSPARENT THIN-FILM SOLAR MODULE" and/or improvements thereof or resulting therefrom to said assignee or its successors,

assigns or nominees, and agree to testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, continuation-in-part and/or reissue applications, make all rightful oaths and/or declarations and generally do everything possible to aid said assignee, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in the United States of America and in all other countries.

Subscribed and executed at Penzance Germany
City Country
On 27-07-2020
Date

Inventor Name: Andreas HEISS

Inventor Signature: [Signature]

Witnessed by:
Witness Name: _____ Signature _____
Witness Name: _____ Signature _____

Subscribed and executed at _____
City Country
On _____
Date

Inventor Name: Joerg PALM

Inventor Signature: _____

Witnessed by:
Witness Name: _____ Signature _____
Witness Name: _____ Signature _____

assigns or nominees, and agree to testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, continuation-in-part and/or reissue applications, make all rightful oaths and/or declarations and generally do everything possible to aid said assignee, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in the United States of America and in all other countries.

Subscribed and executed at _____
City Country

On _____
Date

Inventor Name: Andreas HEISS

Inventor Signature _____

Witnessed by:

Witness Name: _____ Signature _____

Witness Name: _____ Signature _____

Subscribed and executed at Munich Germany
City Country

On July 14, 2020
Date

Inventor Name: Joerg PALM

Inventor Signature _____

Witnessed by:

Witness Name: Hödel Signature _____

Witness Name: Thomas Müller Signature _____

Subscribed and executed at Munich Germany
City Country

On July 15/2020
Date

Inventor Name: Helmut VOGT

Inventor Signature [Signature]

Witnessed by:

Witness Name: Jörg Palm Signature [Signature]

Witness Name: FRANK KARG Signature [Signature]